

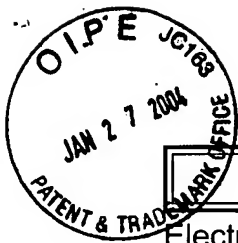


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Electronic Patent Application Submission  
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EFS ID: 54327  
Application ID: 10680280  
Title of Invention: SEMICONDUCTOR PACKAGE AND  
METHOD FOR MANUFACTURING  
THE SAME  
First Named Inventor: Jong Paek  
Domestic/Foreign Application: Domestic Application  
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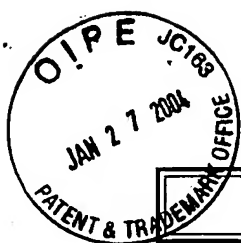


# TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0


Title of Invention	SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING THE SAME									
Application Number: 10/680280 										
Date: 2003-10-07										
First Named Applicant: Jong Sik Paek										
Confirmation Number: 7297										
Attorney Docket Number: AMKOR021G										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Mark B. Garred Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Mark B. Garred Registered Number: 34,823	/mbg/	Attorney		
Submitted by:	Elec. Sign.	Sign. Capacity								
Mark B. Garred Registered Number: 34,823	/mbg/	Attorney								
<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>ids3-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	ids3-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
us-ids	ids3-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
Comments										



## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING THE SAME						
Application Number:		10/680280					
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First Named Applicant:		Jong Paek					
Attorney Docket Number:		AMKOR021G					
Art Unit:		2811					
Search string:		( 5640047 or 5639990 or 5641997 or 5644169 or 5643433 or 5646831 or 5650663 or 5661088 or 5665996 or 5673479 or 5683806 or 5689135 or 5696666 or 5701034 or 5703407 or 5710064 or 5724233 or 5723899 or 5736432 or 5745984 or 5753977 or 5753532 or 5766972 or 5770888 or 5776798 or 5783861 or 5801440 or 5814884 or 5814883 or 5814881 or 5814877 or 5818105 or 5817540 or 5821615 or 5821457 or 5835988 or 5834830 or 5844306 or 5856911 or 5859471 or 5866939 or 5871782 or 5874784 or 5877043 or 5886398 or 5886397 or 5894108 or 5897339 or 5900676 or 5903050 ).pn.					
<h3>US Patent Documents</h3>							
Note: Applicant is not required to submit a paper copy of cited US Patent Documents							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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	50	5903050	1999-05-11	THURAIRAJARATNAM ET AL.

Signature

Examiner Name	Date